

13281 U.S.PTO
033004

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE
PATENT APPLICATION TRANSMITTAL LETTER

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Transmitted herewith for filing pursuant to 37 C.F.R. §1.53 is the patent application of:

INVENTORS:

Hatsuo ISHIDA
2903 Weybridge Road
Shaker Heights, Ohio 44120-1873

Koichi SHIBAYAMA
2-1 Hyakuyama Shimamoto-chou
Osaka 618-8589 JAPAN

Hiroshi ABE
c/o Sekisui Integrated Research, Inc.
3-5-24 Miyahara, Yodogawa-ku
Osaka 532-0003 JAPAN

FOR: A THERMOSETTING RESIN COMPOSITION AND ITS ARTICLE

Enclosed are:

- () sheets of drawings.
 An Assignment of the invention to: Sekisui Chemical Co., Ltd.
 An associate power of attorney.
 A Notice of Informal Filing of New Patent Application.
 A Japanese language Specification, Claims and Abstract.

The filing fee is calculated as follows:

	CLAIMS AS	FILED	SMALL ENTITY		OTHER THAN A SMALL ENTITY
FOR	NO. FILED	NO. EXTRA	RATE FEE		RATE FEE
BASIC FEE			\$375		\$ 770
Total Claims	16-20=	-0-	x9=	or	x18= -0-
Indep claims	8-3=	-5-	X43= -0-	or	x86= \$ 430
[] Multiple	Dep claims		+145= -0-	or	+290= -0-
			TOTAL		TOTAL \$1200

- Check in the amount of \$ 1200.00 is enclosed.
- The Commissioner is hereby authorized to charge \$ to Deposit Account No. 20-1424 for the filing fee listed above.
- The Commissioner is hereby authorized to charge \$ to the credit card identified in the attached Credit Card Payment Form for the filing fee listed above.
- The Commissioner is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Deposit Account No. 20-1424. A duplicate copy of this sheet is attached.
- Any additional fees under 37 CFR 1.16 for the presentation of extra claims.
- Any patent application processing fees under 37 CFR 1.17.
- The Commissioner is hereby authorized to charge payment of the following fees during the pendency of this application or credit any overpayment to Deposit Account No. 20-1424. A duplicate copy of this sheet is attached.
- Any patent application processing fees under 37 CFR 1.17, including extension of time fees.
- Any filing fees under 37 CFR 1.16 for the presentation of extra claims.

Respectfully submitted,

Donald E. Townsend, Jr.

Donald E. Townsend, Jr.
Reg. No. 43,198

Donald E. Townsend

Donald E. Townsend
Reg. No. 22,069

Date: March 30, 2004

LAW OFFICES OF TOWNSEND & BANTA
Suite 900, South Building
601 Pennsylvania Ave., N.W.
Washington, D.C. 20004
(202) 220-3124

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:
H. Ishida, et al.

Serial No.: To Be Assigned Art Unit: To Be Assigned

Filed: Concurrently Herewith Examiner: To Be Assigned

For: A Thermosetting Resin Composition And Its Article

INFORMAL FILING OF NEW PATENT APPLICATION

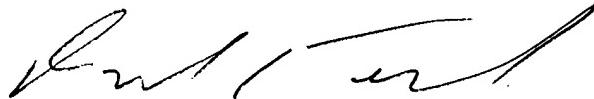
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Alexandria, VA 22313-1450

BOX PATENT APPLICATIONS

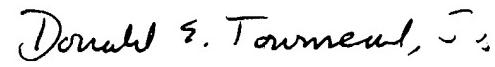
Sir:

The undersigned has been authorized by the Applicants, Hatsuo Ishida, Koichi Shibayama, and Hiroshi Abe, to file the enclosed patent application, and to defer filing of the Declaration/Power of Attorney.

Respectfully submitted,



Donald E. Townsend
Reg. No. 22,069



Donald E. Townsend, Jr.
Reg. No. 43,198

Date: March 30, 2004

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Washington, D.C. 20004
202-220-3124